NVBLSOD5N04M8

MOSFET – Power, Single, N-Channel

40 V, 300 A, 0.57 m Ω

Features

- Typical $R_{DS(on)} = 0.46 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typical $Q_{g(tot)} = 220 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS T_J = 25°C unless otherwise noted

Parameter	Symbol	Ratings	Units
Drain-to-Source Voltage	V _{DSS}	40	٧
Gate-to-Source Voltage	V _{GS}	±20	٧
Drain Current – Continuous ($V_{GS} = 10$) (Note 1) $T_C = 25^{\circ}C$	I _D	300	Α
Pulsed Drain Current T _C = 25°C		See Figure 4	
Single Pulse Avalanche Energy (Note 2)	E _{AS}	1064	mJ
Power Dissipation	P_{D}	429	W
Derate Above 25°C		2.86	W/°C
Operating and Storage Temperature	T _J , T _{STG}	-55 to +175	°C
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.35	°C/W
Maximum Thermal Resistance, Junction-to-Ambient (Note 3)	$R_{ heta JA}$	43	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Current is limited by bondwire configuration.
- 2. Starting T_J = 25°C, \dot{L} = 0.3 mH, I_{AS} = 84 A, V_{DD} = 40 V during inductor charging and V_{DD} = 0 V during time in avalanche.
- 3. $R_{\theta JA}$ is the sum of the junction–to–case and case–to–ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2 oz copper.

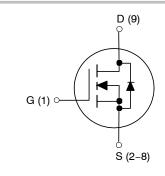


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MO-299A CASE 100CU



ORDERING INFORMATION

Device	Package	Marking
NVBLS0D5N04M8TXG	MO-299A (Pb-Free)	0D5N04M8

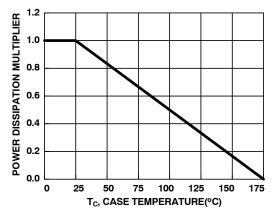
NVBLS0D5N04M8

Table 1. ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Test Co	Test Conditions		Тур	Max	Units
OFF CHA	ARACTERISTICS	•		-	-	-	-
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250 μA	$I_D = 250 \mu A, V_{GS} = 0 V$		-	_	V
I _{DSS}	Drain-to-Source Leakage Current	V _{DS} = 40 V,	T _J = 25°C	-	-	1	μΑ
		$V_{GS} = 0 V$	T _J = 175°C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	V _{GS} =	V _{GS} = ±20 V		-	±100	nA
ON CHA	RACTERISTICS						
V _{GS(th)}	Gate-to-Source Threshold Voltage	$V_{GS} = V_{DS}$	I _D = 250 μA	2.0	3.0	4.0	V
R _{DS(on)}	Drain-to-Source On Resistance	I _D = 80 A, V _{GS} = 10 V	T _J = 25°C	-	0.46	0.57	mΩ
DYNAMI	C CHARACTERISTICS						
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		15900	-	pF
C _{oss}	Output Capacitance				4000	-	pF
C _{rss}	Reverse Transfer Capacitance			-	600	-	pF
Rg	Gate Resistance	f = 1	f = 1 MHz		2.6	-	Ω
Q _{g(ToT)}	Total Gate Charge at 10 V	V _{GS} = 0 to 10 V	V _{DD} = 20 V I _D = 80 A	-	220	296	nC
Q _{g(th)}	Threshold Gate Charge	V _{GS} = 0 to 2 V		-	29	39	nC
Q_{gs}	Gate-to-Source Gate Charge			-	73	-	nC
Q_{gd}	Gate-to-Drain "Miller" Charge			-	41	-	nC
SWITCH	ING CHARACTERISTICS						
t _{on}	Turn-On Time	V _{DD} = 20 V	V_{DD} = 20 V, I_{D} = 80 A, V_{GS} = 10 V, R_{GEN} = 6 Ω		-	221	ns
t _{d(on)}	Turn-On Delay	V _{GS} = 10 V,			54	-	ns
t _r	Rise Time			-	82	-	ns
t _{d(off)}	Turn-Off Delay				106	-	ns
t _f	Fall Time				52	-	ns
t _{off}	Turn-Off Time				-	215	ns
DRAIN-S	SOURCE DIODE CHARACTERISTICS						
V_{SD}	Source-to-Drain Diode Voltage	I _{SD} = 80 A, V _{GS} = 0 V		-	-	1.25	V
		I _{SD} = 40 A,	, V _{GS} = 0 V	-	-	1.2	V
t _{rr}	Reverse-Recovery Time	I _F = 80 A, dI _{SD}	$I_F = 80 \text{ A, } dI_{SD}/d_t = 100 \text{ A/}\mu\text{s,}$ $V_{DD} = 32 \text{ V}$		119	133	ns
Q _{rr}	Reverse-Recovery Charge	V _{DD} =			228	274	nC

^{4.} The maximum value is specified by design at T_J = 175°C. Product is not tested to this condition in production. Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Typical Characteristics



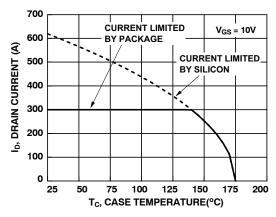


Figure 1. Normalized Power Dissipation vs. Case Temperature

Figure 2. Maximum Continuous Drain Current vs.

Case Temperature

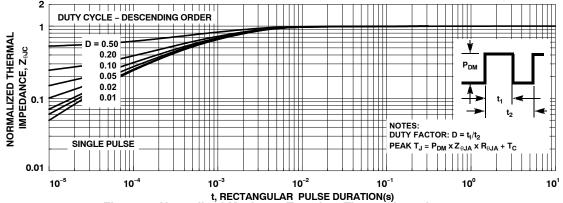


Figure 3. Normalized Maximum Transient Thermal Impedance

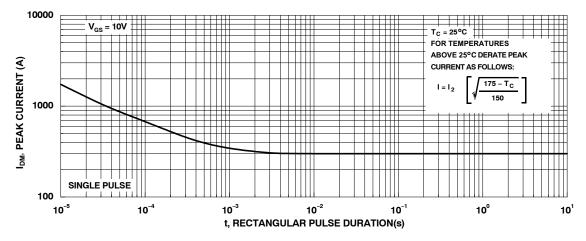


Figure 4. Peak Current Capability

Typical Characteristics

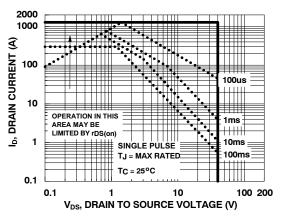
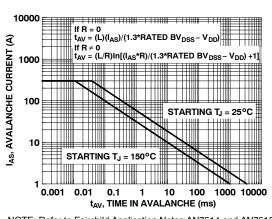


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability

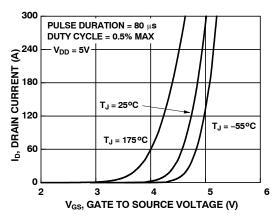


Figure 7. Transfer Characteristics

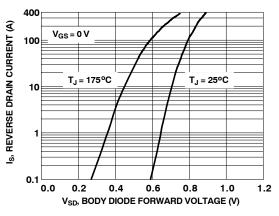


Figure 8. Forward Diode Characteristics

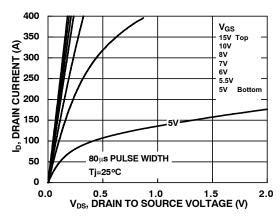


Figure 9. Saturation Characteristics

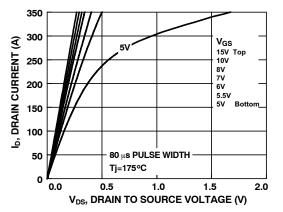


Figure 10. Saturation Characteristics

NVBLS0D5N04M8

Typical Characteristics

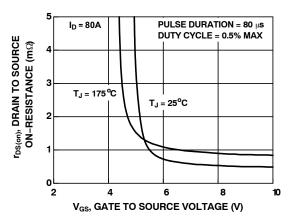


Figure 11. R_{DSON} vs. Gate Voltage

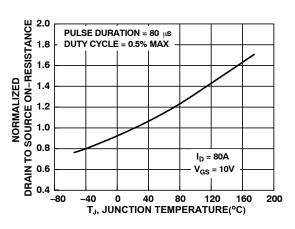


Figure 12. Normalized R_{DSON} vs. Junction Temperature

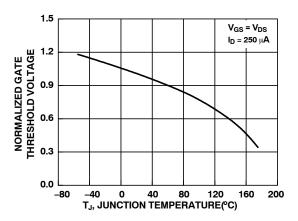


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

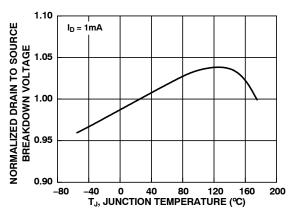


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

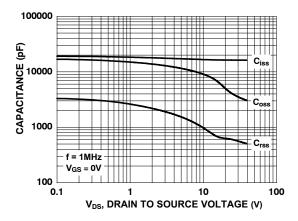


Figure 15. Capacitance vs. Drain to Source Voltage

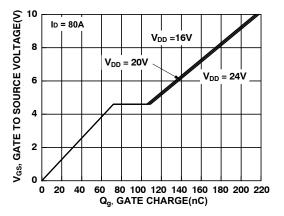
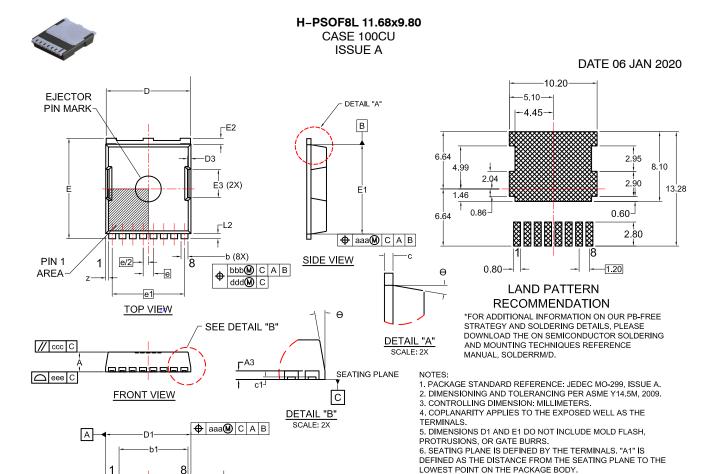


Figure 16. Gate Charge vs. Gate to Source Voltage

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DIM	MILLIMETERS			
5	MIN.	NOM.	MAX.	
Α	2.20	2.30	2.40	
A3	0.40	0.50	0.60	
b	0.70	0.80	0.90	
b1		8.00 REF	-	
С	0.40	0.50	0.60	
c1	0.10			
D	9.70	9.80	9.90	
D1	9.80	9.90	10.00	
D2	4.73 BSC			
D3	0.40 REF			
D4	3.75 BSC			
D5	_	1.20		
D6	7.40	7.50	7.60	
D7	(8.30)			
E	11.58	11.68	11.78	
E1	10.28	10.38	10.48	
E2	0.60	0.70	0.80	
E3	3.30 REF			

E4

DIM	MIL	LIMETE	RS
Divi	MIN.	NOM.	MAX.
е	1.20 BSC		
e/2	0.60 BSC		
e1		3.40 BSC	;
K	1.50	1.57	1.70
L	1.90	2.00	2.10
L2	0.50	0.60	0.70
Z	0.35 REF		
θ	0°		12°
aaa	0.20		
bbb	0.25		
ccc	0.20		
ddd	0.20		
eee	0.10		
E5	-	3.30	_
E6		0.65	_
E7	7.15 REF		
E8	6.55	6.65	6.75
E9	5.89 BSC		
E10	5.19 BSC		

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

2.60

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H.A.A.A.A.A.A

|--D5 (3X)

D4 -

-D7

BOTTOM VIEW

E10

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E5 (2X) ⊢E6 (2X)

Α

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GENERIC
MARKING DIAGRAM*

AYWWZZ

XXXXXXXX

= Year

= Work Week

XXXX = Specific Device Code

= Assembly Location

= Assembly Lot Code

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